USB 2.0 High Speed, UART and Audio Switch with Negative Signal Capability

NCN1154

The NCN1154 is a DP3T switch for combined true−ground audio, USB 2.0 high speed data, and UART applications. It allows portable systems to use a single port to pass either high speed data or audio signals from an external headset; the 3 channels being compliant to USB 2.0, USB 1.1 and USB 1.0.

The switch is capable of passing signals with negative voltages as low as 2 V below ground. The device features shunt resistors on the audio ports. These resistors are switched in when the audio channel is off and provide a safe path to ground for any charge that may build up on the audio lines. This reduces Pop & Click noise in the audio system.

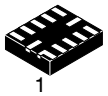
The NCN1154 is housed in a space−saving, ultra low profile 2.0x1.7x0.5mm, 12 pin UQFN package.

Features

- 3:1 High Speed Switch
- USB 2.0, USB 1.1 & USB 1.0 Capable on all Channels
- High Bandwidth of 820 MHz on D+/D−
- Capable of Passing Negative Swing Signals Down to −2 V on R/L Channel
- 1.8 V Compatible Control Pins for 2.7 V $\leq$ V_{CC} $\leq$ 4.2 V
- Audio Channel Shunt Resistors for Pop & Click Noise Reduction
- Ultra Low THD in Audio Mode: 0.01% into 16 Ω Load
- 5.25 V Tolerant Common Pins
- This is a Pb−Free Device

Typical Applications

- Micro or Mini USB Applications
- Shared High Speed Data or Audio on a Single Connector
- Mobile Phones
- Tablets
- Bar Code Scanners
- Portable Devices

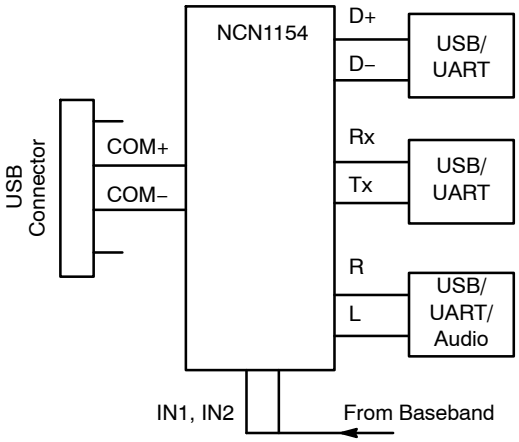


UQFN12
MU SUFFIX
CASE 523AE

MARKING DIAGRAM

AC = Specific Device Code
M = Date Code
▪ = Pb−Free Package

APPLICATION DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping†
NCN1154MUTAG	UQFN12 (Pb−Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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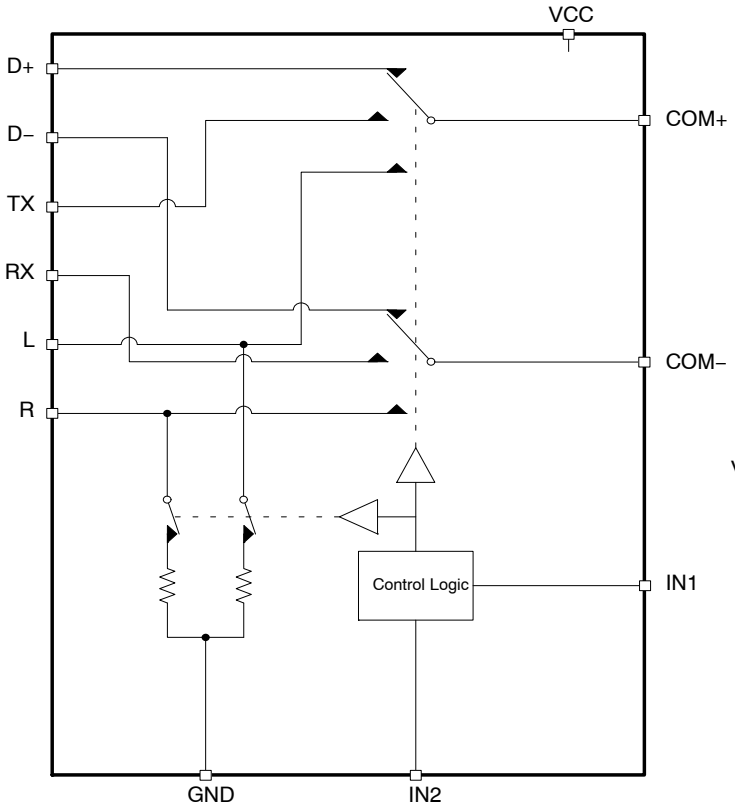

Figure 1. Functional Block Diagram

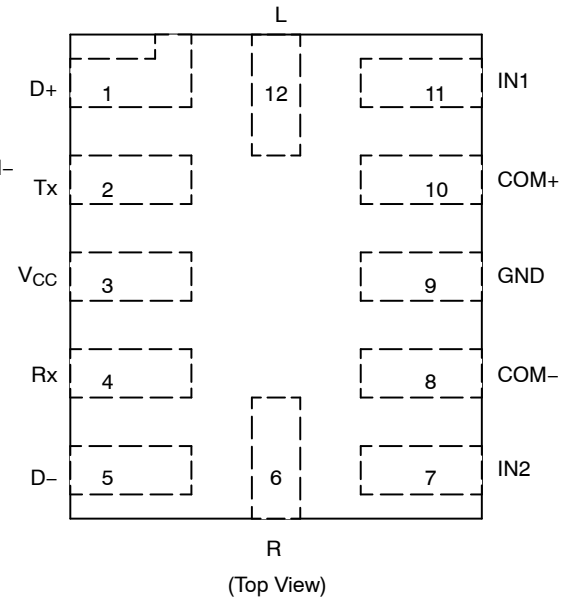

Figure 2. Pinout Diagram

PIN DESCRIPTIONS

Pin #	Name	Direction	Description
1	D+	I/O	Positive Data Line for USB Signals
2	Tx	I/O	Transmit Data Line for UART Signals
3	V_{CC}	Power	Power Supply
4	Rx	I/O	Receive Data Line for UART Signals
5	D−	I/O	Negative Data Line for USB Signals
6	R	I/O	Right Line for Audio Signals
7	IN2	Input	Control Input Select Line
8	COM−	I/O	Right Audio / Negative Data Common Line
9	GND	Power	Ground
10	COM+	I/O	Left Audio / Positive Data Common Line
11	IN1	Input	Control Input Select Line
12	L	I/O	Left Line for Audio Signals

TRUTH TABLE

IN1	IN2	D+, D−	R_X/T_X	L, R	L, R SHUNT
0	0	Hi Z	Hi Z	Hi Z	ON
0	1	ON	Hi Z	Hi Z	ON
1	0	Hi Z	Hi Z	ON	OFF
1	1	Hi Z	ON	Hi Z	ON

OPERATING CONDITIONS

MAXIMUM RATINGS

Symbol	Pins	Parameter	Value	Unit
V_{CC}	V_{CC}	Positive DC Supply Voltage	−0.5 to +6.0	V
V_{IS}	R, L, D+, D−, Rx, Tx	Analog I/O	−2.5 to V_{CC} + 0.5	V
	COM+, COM−		−2.5 to +6.0	
V_{IN}	IN1, IN2	Control Input Voltage	−0.5 to +6.0	V
I_{CC}	V_{CC}	Positive DC Supply Current	50	mA
T_S		Storage Temperature	−65 to +150	°C
I_{IS_CON}	COM+, COM−, R, L, D+, D−, Rx, Tx	Analog Signal Continuous Current−Closed Switch	±100	mA
I_{IS_PK}	COM+, COM−, R, L, D+, D−, Rx, Tx	Analog Signal Continuous Current 10% Duty Cycle	±500	mA
I_{IN}	IN1, IN2	Control Input Current	1.0	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

NOTE: These devices have limited built−in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage.

RECOMMENDED OPERATING CONDITIONS

Symbol	Pins	Parameter	Min	Max	Unit
V_{CC}	V_{CC}	Positive DC Supply Voltage	2.7	5.0	V
V_{IS}	D+ to COM+, D− to COM−	Analog Signal Voltage (Note 1)	GND	V_{CC}	V
	L to COM+, R to COM−		−2.0	V_{CC}	
	Tx to COM+, Rx to COM−		GND	V_{CC}	
V_{IN}	IN1, IN2	Control Input Voltage	GND	V_{CC}	V
T_A		Operating Temperature	−40	+85	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

1. In USB mode, any signal supplied to the off−state audio inputs R, L may not swing below ground or above 1.5 V.

DC ELECTRICAL CHARACTERISTICS

CONTROL INPUT Min and Max apply for T_A between −40°C to +85°C and T_J up to +125°C (Unless otherwise noted). Typical values are referenced to T_A = +25°C, V_{CC} = 3.3 V.

Symbol	Pins	Parameter	Test Conditions	V_{CC} (V)	−40°C to +85°C			Unit
					Min	Typ	Max	
V_{IH}	IN1, IN2	Control Input HIGH Voltage		2.7 3.3 4.2	1.3 1.4 1.5	−	−	V
V_{IL}	IN1, IN2	Control Input LOW Voltage		2.7 3.3 4.2	−	−	0.4 0.4 0.4	V
I_{IN}	IN1, IN2	Current Input Leakage Current	$0 \le V_{IS} \le V_{CC}$		−	−	±50	nA

SUPPLY CURRENT AND LEAKAGE Min and Max apply for T_A between −40°C to +85°C and T_J up to +125°C (Unless otherwise noted). Typical values are referenced to T_A = +25°C, V_{CC} = 3.3 V.

Symbol	Pins	Parameter	Test Conditions	V_{CC} (V)	−40°C to +85°C			Unit
					Min	Typ	Max	
$I_{NC,NO(OFF)}$	D+, D− R, L Tx, Rx	OFF State Leakage	V_{COM-}, V_{COM+} = 0 V, 4.2 V V_{D+}, V_{D-} = 4.2 V, 0 V or float V_L, V_R = float or 4.2 V, 0 V	4.2			±80	nA
$I_{COM(ON)}$	COM−, COM+	ON State Leakage	V_{COM-}, V_{COM+} = 0 V, 4.2 V V_{D+}, V_{D-} = 4.2 V, 0 V or float V_L, V_R = float or 4.2 V, 0 V	4.2			±100	nA
I_{CC}	V_{CC}	Quiescent Supply	V_{IS} = GND to V_{CC}; I_D = 0 A	4.2		21	35	μA
I_{OFF}	COM−, COM+	Power OFF Leakage	0 ≤ V_{IS} ≤ 5.0 V	0			50	μA

USB ON RESISTANCE Min and Max apply for T_A between −40°C to +85°C and T_J up to +125°C (Unless otherwise noted). Typical values are referenced to T_A = +25°C, V_{CC} = 3.3 V.

Symbol	Pins	Parameter	Test Conditions	V_{CC} (V)	−40°C to +85°C			Unit
					Min	Typ	Max	
R_{ON}	D+ to COM+ D− to COM−	On−Resistance	I_{ON} = 10 mA V_{IS} = 0 V to V_{CC}	2.7 3.3 4.2		5.5 5.5 5.5	7.5 7.5 7.5	Ω
R_{FLAT}	D+ to COM+ D− to COM−	On−Resistance Flatness	I_{ON} = 10 mA V_{IS} = 0 V to V_{CC}	2.7 3.3 4.2		0.08 0.08 0.08		Ω
ΔR_{ON}	D+ to COM+ D− to COM−	On−Resistance Matching	I_{ON} = 10 mA V_{IS} = 0 V to V_{CC}	2.7 3.3 4.2		0.03 0.03 0.03		Ω

AUDIO ON RESISTANCE Min and Max apply for T_A between −40°C to +85°C and T_J up to +125°C (Unless otherwise noted). Typical values are referenced to T_A = +25°C, V_{CC} = 3.3 V.

Symbol	Pins	Parameter	Test Conditions	V_{CC} (V)	−40°C to +85°C			Unit
					Min	Typ	Max	
R_{ON}	R to COM+ L to COM−	On−Resistance	I_{ON} = 10 mA V_{IS} = −1.5 to 1.5	2.7 3.3 4.2		3.0 3.0 3.0	4.7 4.7 4.7	Ω
R_{FLAT}	R to COM+ L to COM−	On−Resistance Flatness	I_{ON} = 10 mA V_{IS} = −1.5 to 1.5	2.7 3.3 4.2		0.11 0.11 0.11		Ω
ΔR_{ON}	R to COM+ L to COM−	On−Resistance Matching	I_{ON} = 10 mA V_{IS} = −1.5 to 1.5	2.7 3.3 4.2		0.03 0.03 0.03		Ω
R_{SH}	L, R	Shunt Resistance (Resistor + Switch)	I_{ON} = 10 mA	2.7 − 4.2		118	160	Ω

UART ON RESISTANCE Min and Max apply for T_A between −40°C to +85°C and T_J up to +125°C (Unless otherwise noted). Typical values are referenced to T_A = +25°C, V_{CC} = 3.3 V.

Symbol	Pins	Parameter	Test Conditions	V_{CC} (V)	−40°C to +85°C			Unit
					Min	Typ	Max	
R_{ON}	Tx to COM+ Rx to COM−	On−Resistance	I_{ON} = 10 mA V_{IS} = 0 V to V_{CC}	2.7 3.3 4.2		5.5 5.5 5.5	7.5 7.5 7.5	Ω

UART ON RESISTANCE Min and Max apply for T_A between −40°C to +85°C and T_J up to +125°C (Unless otherwise noted). Typical values are referenced to T_A = +25°C, V_{CC} = 3.3 V.

Symbol	Pins	Parameter	Test Conditions	V_{CC} (V)	−40°C to +85°C			Unit
					Min	Typ	Max	
R_{FLAT}	Tx to COM+ Rx to COM−	On−Resistance Flatness	I_{ON} = 10 mA V_{IS} = 0 V to V_{CC}	2.7 3.3 4.2		0.08 0.08 0.08		Ω
ΔR_{ON}	Tx to COM+ Rx to COM−	On−Resistance Matching	I_{ON} = 10 mA V_{IS} = 0 V to V_{CC}	2.7 3.3 4.2		0.03 0.03 0.03		Ω

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

AC ELECTRICAL CHARACTERISTICS

TIMING/FREQUENCY Min and Max apply for T_A between −40°C to +85°C and T_J up to +125°C (Unless otherwise noted). Typical values are referenced to T_A = +25°C, V_{CC} = 3.3 V. R_L = 50 Ω, C_L = 35 pF, f = 1 MHz.

Symbol	Pins	Parameter	Test Conditions	V_{CC} (V)	−40°C to +85°C			Unit
					Min	Typ	Max	
t_{ON}		Turn−ON Time (Closed to Open)				15		μs
t_{OFF}		Turn−OFF Time (Closed to Open)				67		ns
T_{BBM}		Break−Before−Make Time				11		μs
BW	D+ / D- Tx / Rx R / L	−3 dB Bandwidth	C_L = 5 pF R_S = 50 Ω			820 800 750		MHz

ISOLATION Min and Max apply for T_A between −40°C to +85°C and T_J up to +125°C (Unless otherwise noted). Typical values are referenced to T_A = +25°C, V_{CC} = 3.3 V. R_L = 50 Ω, C_L = 5 pF.

Symbol	Pins	Parameter	Test Conditions	V_{CC} (V)	−40°C to +85°C			Unit
					Min	Typ	Max	
O_{IRR}	Open	OFF−Isolation	f = 100 kHz, R_S = 50 Ω			−81		dB
X_{TALK}	COM+ to COM−	Non−Adjacent Channel Crosstalk	f = 100 kHz, R_S = 50 Ω			−93		dB
THD+N		Total Harmonic Distortion + Noise	IN1, IN2 = 3.0 V f = 20 Hz to 20 kHz V_{COM} = 0.5 V_{pp} R_L = 600 Ω	3.0		0.001		%
PSRR		Power Supply Rejection Ratio	f = 10 kHz R_{COM} = 50 Ω	3.0		60		dB

CAPACITANCE Min and Max apply for T_A between −40°C to +85°C and T_J up to +125°C (Unless otherwise noted). Typical values are referenced to T_A = +25°C, V_{CC} = 3.3 V. R_L = 50 Ω, C_L = 5 pF, f = 1 MHz.

Symbol	Pins	Parameter	Test Conditions	−40°C to +85°C			Unit
				Min	Typ	Max	
C_{IN}	IN1, IN2	Control Pin Input Capacitance	V_{CC} = 0 V		2.0		pF
C_{ON}	D+, Tx to COM+ D−, Rx to COM−	USB, UART ON Capacitance			9.0		pF
C_{ON}	R to COM+ L to COM−	Audio ON Capacitance			8.5		pF
C_{OFF}	D+, D− Tx, Rx	USB, UART OFF Capacitance			3.5		pF

TABLE OF GRAPHS

Symbol	Parameter	Figure
NE	Near End Signaling Eye Diagram	3, 4, 5, 6
FE	Far End Signaling Eye Diagram	7, 8, 9, 10
BW	Frequency Response	11, 12, 13

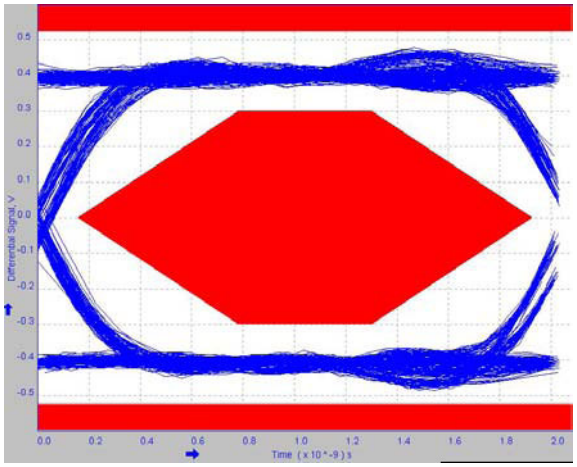

Figure 3. Reference Near End Eye Diagram (Path Trough Dedicated Line, Temp = 25°C)

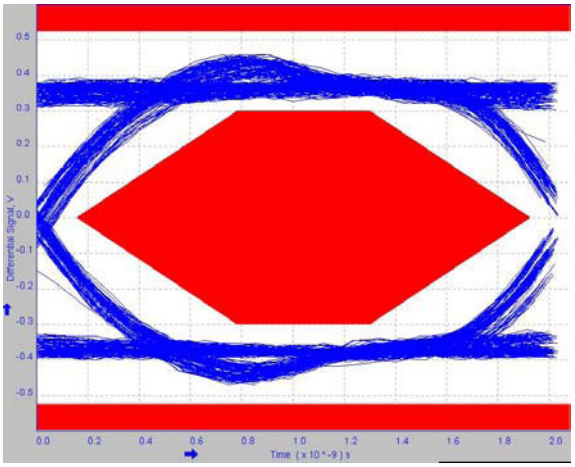

Figure 4. USB Switch Near End Eye Diagram (V_{CC} = 3.6 V, IN1 = 0, IN2 = 1, Temp = 25°C)

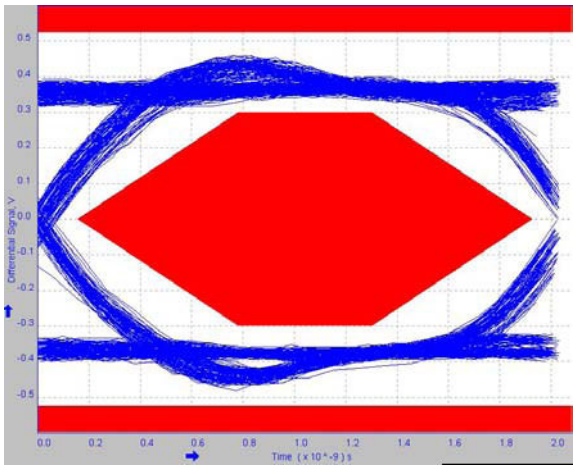

Figure 5. UART Switch Near End Eye Diagram (V_{CC} = 3.6 V, IN1 = 1, IN2 = 1, Temp = 25°C)

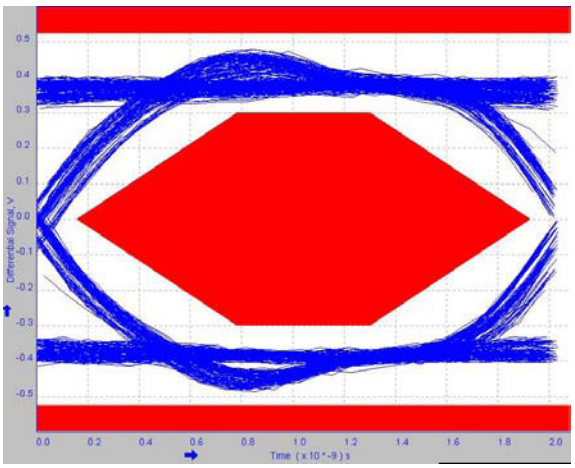

Figure 6. Audio Switch Near End Eye Diagram (V_{CC} = 3.6 V, IN1 = 1, IN2 = 0, Temp = 25°C)

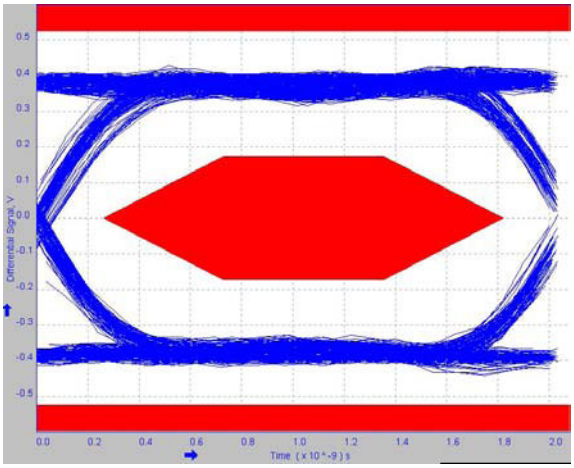

Figure 7. Reference Far End Eye Diagram
(Path Trough Dedicated Line, Temp = 25°C)

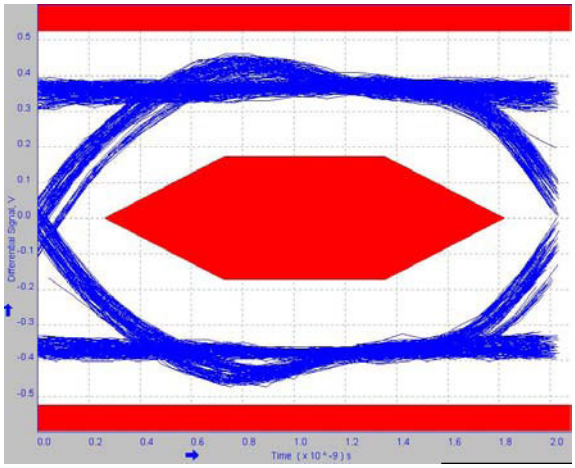

Figure 8. USB Switch Far End Eye Diagram
(V_{CC} = 3.6V, IN1 = 0, IN2 = 1, Temp = 25°C)

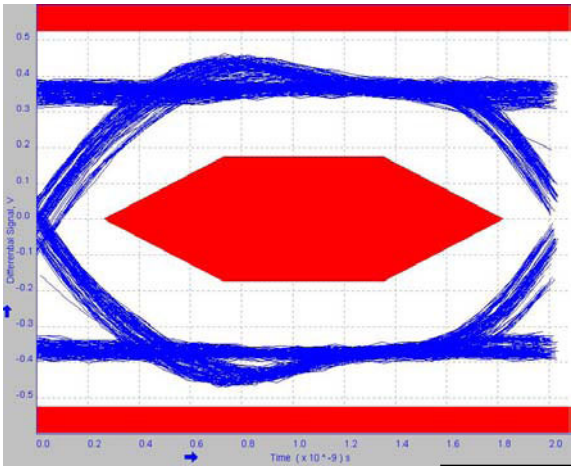

Figure 9. UART Switch Far End Eye Diagram
(Vcc = 3.6 V, IN1 = 1, IN2 = 1, Temp = 25°C)

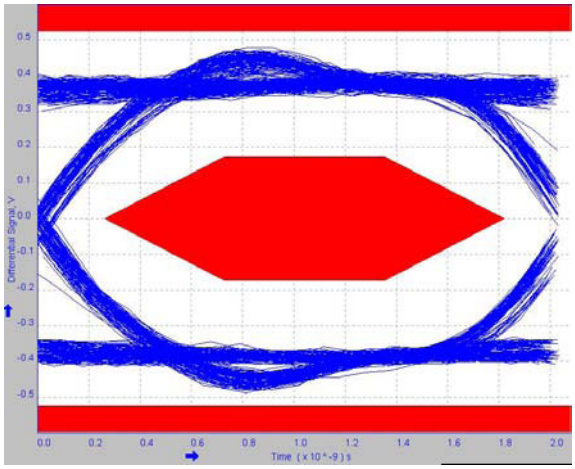

Figure 10. Audio Switch Far End Eye Diagram
(V_{CC} = 3.6 V, IN1 = 1, IN2 = 0, Temp = 25°C)

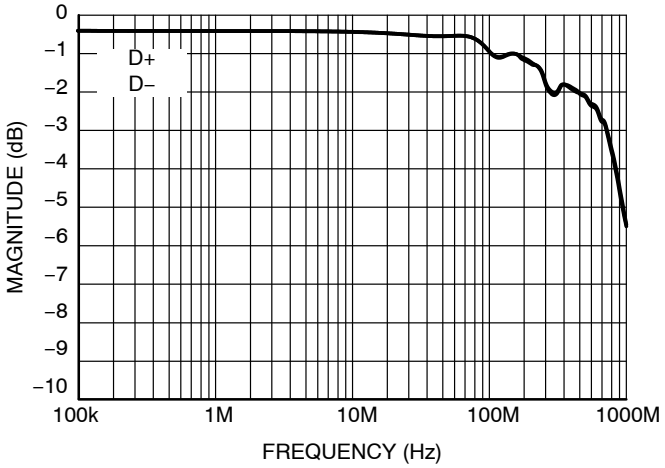

Figure 11. USB Path Frequency Response

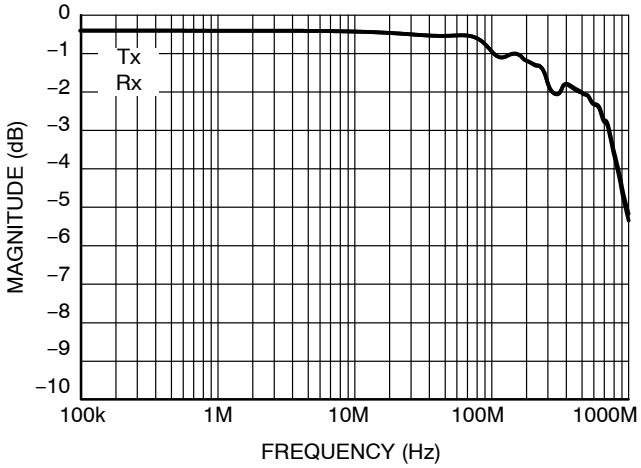

Figure 12. UART Path Frequency Response

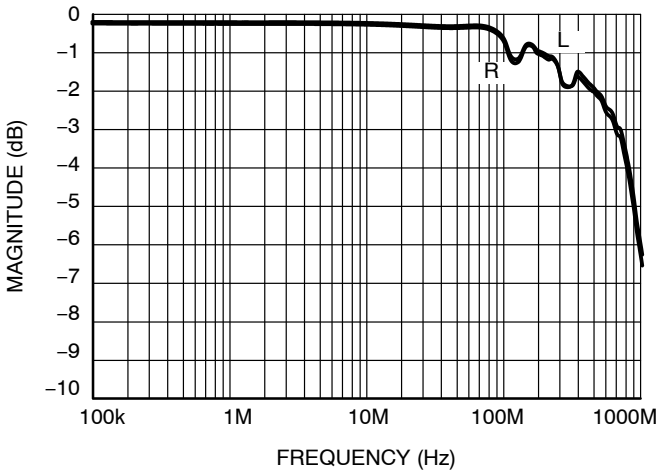

Figure 13. Audio Path Frequency Response

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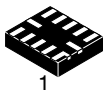
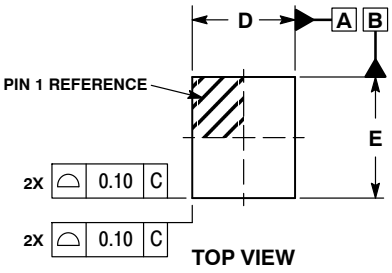
ISSUE A

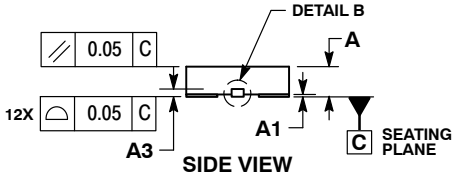
DATE 11 JUN 2007



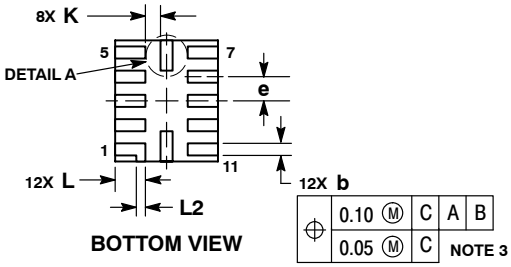
SCALE 4:1



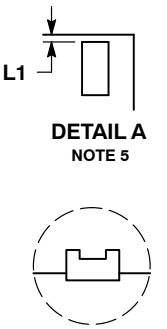
TOP VIEW



SIDE VIEW



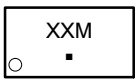
BOTTOM VIEW



NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM TERMINAL TIP.
4. MOLD FLASH ALLOWED ON TERMINALS ALONG EDGE OF PACKAGE. FLASH 0.03 MAX ON BOTTOM SURFACE OF TERMINALS.
5. DETAIL A SHOWS OPTIONAL CONSTRUCTION FOR TERMINALS.

	MILLIMETERS	
DIM	MIN	MAX
A	0.45	0.55
A1	0.00	0.05
A3	0.127 REF	
b	0.15	0.25
D	1.70 BSC	
E	2.00 BSC	
e	0.40 BSC	
K	0.20	----
L	0.45	0.55
L1	0.00	0.03
L2	0.15 REF	

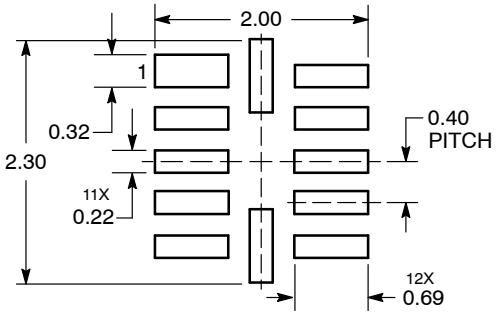
GENERIC MARKING DIAGRAM*



XX = Specific Device Code
M = Date Code
▪ = Pb−Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, “G” or microdot “ ▪”, may or may not be present.

MOUNTING FOOTPRINT
SOLDERMASK DEFINED



DIMENSIONS: MILLIMETERS

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